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Resistivity reduction in Ga-doped ZnO films with a barrier layer that prevents Zn

desorption

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Abstract

The improvement of electrical properties by thermal annealing of Ga-doped

ZnO (GZO) films deposited by sputtering has been investigated. The resistivity of a GZO

film deposited at room temperature decreases as the vacuum annealing temperature is

increased up to 400 °C. A further increase in annealing temperature increases the

resistivity, resulting from a decrease in carrier density. On the other hand, the formation

of a SiO₂ layer covering the surface of the GZO film eliminates this resistivity upturn,

causing its decrease from $1.26 \times 10^{-3} \Omega$ cm before annealing to $4.1 \times 10^{-4} \Omega$ cm at 600 °C. A

comparison between the films annealed at different vacuum pressures have revealed that

electrical resistivity is improved by preventing atomic migration between the GZO lattice

and the surrounding atmosphere, i.e., oxygen absorption to or Zn desorption from the

GZO lattice. The optical transmittance of a SiO₂-capped GZO film is higher than that of

a bare GZO film after thermal annealing.

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